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# (12) United States Patent

### Kaneko

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### (54) COATING AND DEVELOPING APPARATUS, METHOD OF OPERATING THE SAME AND STORAGE MEDIUM

(71) Applicant: TOKYO ELECTRON LIMITED,

Tokyo (JP)

(72) Inventor: Tomohiro Kaneko, Koshi (JP)

(73) Assignee: Tokyo Electron Limited, Minato-Ku

(JP)

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#### (58) Field of Classification Search

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Primary Examiner — Rodney Fuller

(74) Attorney, Agent, or Firm — Burr & Brown, PLLC

#### (57) ABSTRACT

A coating and developing apparatus includes: first and second transfer mechanisms for transferring a substrate from a first mount module to a second mount module, one of the first and second transfer mechanisms being selected each time when the substrate transfer should be performed; first and second processing modules for performing substrate processing, for which the transfer of substrates is performed by the first and second transfer mechanisms, respectively; and a control unit. The control unit controls the transfer mechanisms for the substrate transfer by determining a delay time, representing a delay caused by the transfer of the substrate to the second mount module to the timing of transfer of a substrate from the first/second processing module, in regard to each of the first and second transfer mechanisms and selecting one of the first and second transfer mechanisms whose delay time is the shortest.

## 9 Claims, 15 Drawing Sheets

